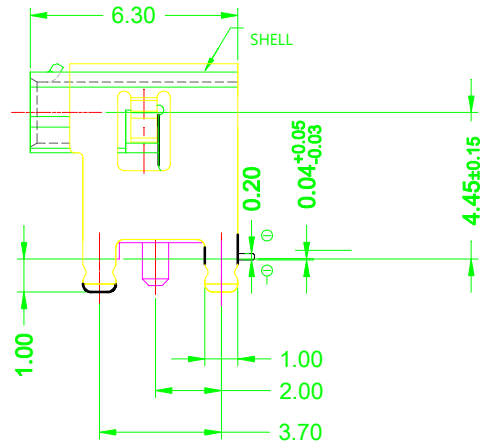
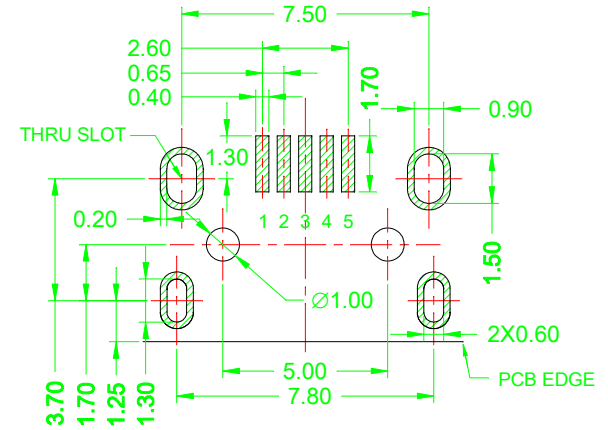


MUB5B-01XXB445

Contact Finish:  
 00: Material 10: 10u"Gold  
 01: G/F 15: 15u"Gold  
 05: 5u"Gold 30: 30u"Gold



- MATERIAL**  
 HOUSING: LCP,UL94V-0,BLACK  
 CONTACT: COPPER ALLOY,T=0.20  
 SHELL: STAINLESS STEEL,T=0.3  
 COVER: STAINLESS STEEL,T=0.25
- FINISH**  
 CONTACT: 50U" MIN NICKEL UNDERPLATING OVERALL  
 GOLD PLATING SELECTIVE ON CONTACT AREA  
 50U" MIN TIN PLATING ON SOLDER TAIL  
 SHELL: 40U" MIN NICKEL UNDERPLATING OVERALL  
 COVER: 40U" MIN NICKEL UNDERPLATING OVERALL
- ELECTRICAL**  
 CURRENT: 1.0A  
 VOLTAGE: 30V  
 CONTACT RESISTANCE: 50 MILLIOHMS MAX.  
 DIELECTRIC WITHSTANDING VOLTAGE: 500V AC  
 INSULATION RESISTANCE: 100 MEGOHMS MIN.
- MECHANICAL**  
 MATING FORCE: 35N MAX.  
 UNMATING FORCE: 10N MIN,INITIAL.  
 8-20N AFTER 10000 CYCLES.  
 DURABILITY: 10000 CYCLES
- PRODUCT NO. DESCRIPTION:**



RECOMMENDED PCB LAYOUT  
 (PCB T=1.60mm)



# 深圳市顺宏康科技有限公司

尺寸	允许公差
X	±0.50
X	±0.20
XX	±0.10
XXX	±0.03
角度	±1.00°

图纸类型	图纸名称: MICRO USB 5P B-F SMT
产品工程图	CL=4.45(短脚1.0, 无边)
设计	产品料号 SHK-20164
审核	视图  版号: A/0